

Contents

1 Schematic 3

2 Pin configuration 4

3 Maximum ratings 5

4 Electrical characteristics 6

5 Typical application 9

6 Application notes 10

7 Typical performance characteristics 11

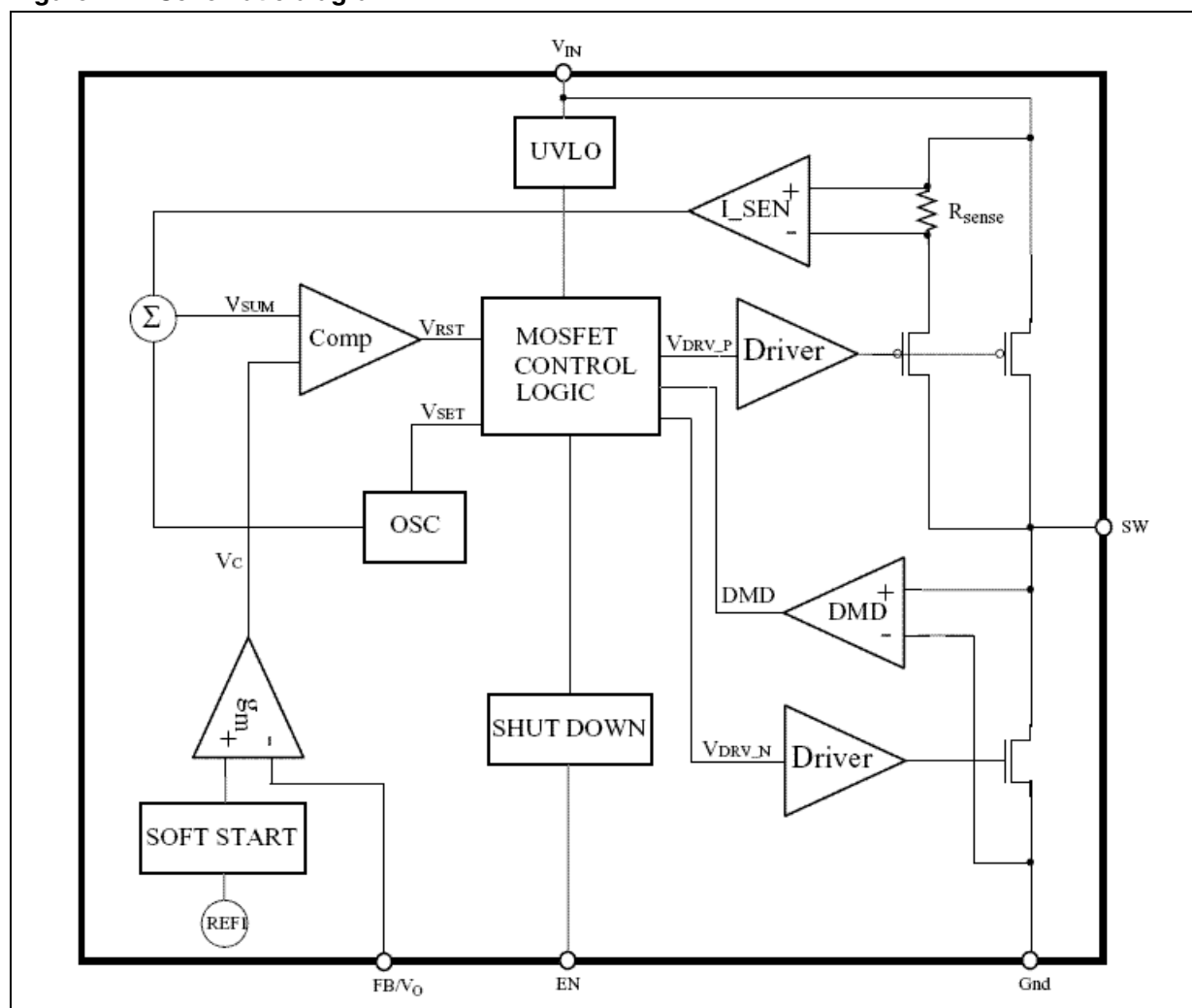
8 Package mechanical data 15

9 Revision history 19



1 Schematic

Figure 1. Schematic diagram



2 Pin configuration

Figure 2. Pin connections (top view)

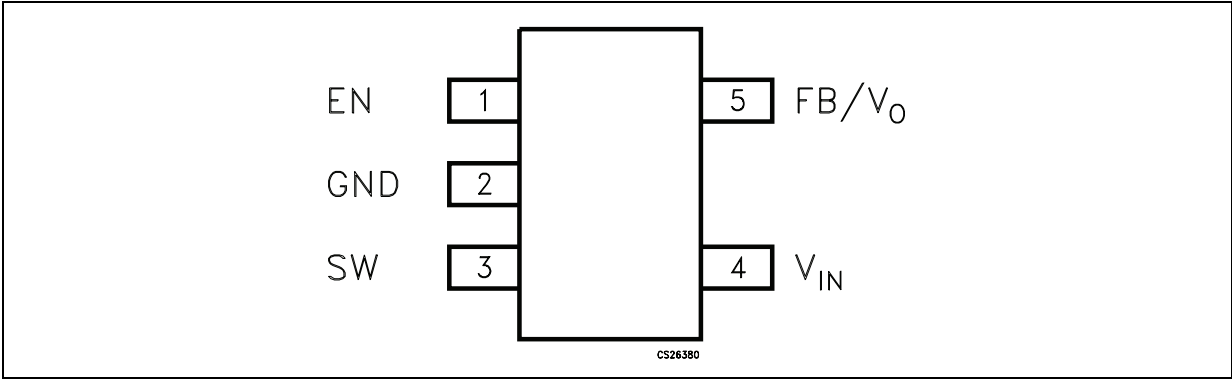


Table 2. Pin description

Pin n°	Symbol	Name and function
1	EN	Enable pin
2	GND	System ground
3	SW	Switching pin
4	V _{IN}	Input supply pin
5	FB/V _O	Feedback voltage / or output voltage

3 Maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{IN}	Positive power supply voltage	-0.3 to 6.5	V
V_{EN}	Enable voltage	-0.3 to $V_{IN} + 0.3$	V
SWITCH Voltage	Max. voltage of output pin	-0.3 to $V_{IN} + 0.3$	V
V_{FB}/V_O	Feedback voltage	-0.3 to 3	V
V_O	Output voltage (for $V_O > 1.6$ V)	-0.3 to 6	V
T_J	Max junction temperature	-40 to 150	°C
T_{STG}	Storage temperature range	-65 to 150	°C
T_{LEAD}	Lead temperature (soldering) 10 sec	260	°C

Note: Absolute maximum ratings are the values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

Table 4. Thermal data

Symbol	Parameter	Value	Unit
R_{thJA}	Thermal resistance junction-ambient	220	°C/W
R_{thJC}	Thermal resistance junction-case	110	°C/W

Table 5. ESD performance

Symbol	Parameter	Test conditions	Value	Unit
ESD	ESD protection voltage	HBM	2	kV
		MM	0.3	kV

4 Electrical characteristics

$V_{IN} = V_{EN} = 3.6\text{ V}$, $C_{IN} = 4.7\text{ }\mu\text{F}$, $C_O = 10\text{ }\mu\text{F}$, $L = 2.2\text{ }\mu\text{H}$, $T_J = -40\text{ to }125\text{ }^\circ\text{C}$ (unless otherwise specified. Typical values are referred to $25\text{ }^\circ\text{C}$).

Table 6. Electrical characteristics for ST1S12G

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
FB	Feedback voltage	$T_J = -40\text{ to }125^\circ\text{C}$	582	600	618	mV
I_{FB}	V_{FB} pin bias current		-50		50	nA
V_{IN}	Minimum input voltage	$I_O = 10\text{ mA to }0.7\text{ A}$	2.5			V
I_Q	Quiescent current	$V_{IN} = V_{EN}$, $V_{FB} = 0.65\text{ V}$		500	650	μA
		$V_{EN} = 0$, $T_J = -40^\circ\text{C to }85^\circ\text{C}$			1	μA
I_O	Output current	$V_{IN} = 2.5\text{ V to }5.5\text{ V}^{(1)}$	0.7			A
V_{EN}	Enable threshold	Device ON, $V_{IN} = 2.5\text{ V to }5.5\text{ V}$	1.5			V
		Device OFF			0.5	
I_{EN}	Enable pin current				1	μA
$\%V_O/\Delta V_{IN}$	Reference line regulation	$V_{IN} = 2.5\text{ V to }5.5\text{ V}^{(1)}$		0.05	0.1	$\%V_O/\Delta V_{IN}$
$\%V_O/\Delta I_O$	Reference load regulation	$I_O = 10\text{ mA to }700\text{ mA}^{(1)}$		0.0025	0.005	$\%V_O/\text{mA}$
PWMf _S	PWM switching frequency		1.16	1.7	2.08	MHz
D _{MAX}	Maximum duty cycle				100	%
R _{DS(on)-N}	NMOS switch on resistance	$I_{SW} = 100\text{ mA}$		0.25	0.4	Ω
R _{DS(on)-P}	PMOS switch on resistance	$I_{SW} = 100\text{ mA}$		0.25	0.45	Ω
I_{SWL}	Switching current limitation	⁽¹⁾		1.6		A
η	Efficiency ⁽¹⁾	$I_O = 10\text{ mA to }100\text{ mA}$, $V_O = 1.8\text{ V}$		80		%
		$I_O = 100\text{ mA to }0.7\text{ A}$, $V_O = 1.8\text{ V}$		90		
T _{SHDN}	Thermal shutdown		130	150		$^\circ\text{C}$
T _{HYS}	Thermal shutdown hysteresis			15		$^\circ\text{C}$
$\%V_O/\Delta I_O$	Load transient response	$I_O = 100\text{ mA to }700\text{ mA}$, $T_A = 25^\circ\text{C}$ $t_R = t_F \geq 200\text{ ns}$, $C_O = 22\text{ }\mu\text{F}^{(1)}$	-5		+5	$\%V_O$
$\%V_O/\Delta I_O$	Short circuit removal response	$I_O = 10\text{ mA to }I_{O=short}$, $T_A = 25^\circ\text{C}^{(1)}$	-10		+10	$\%V_O$

1. Guaranteed by design, but not tested in production.

$V_{IN} = V_{EN} = 3\text{ V}$, $C_{IN} = 4.7\text{ }\mu\text{F}$, $C_O = 10\text{ }\mu\text{F}$, $L = 2.2\text{ }\mu\text{H}$, $T_J = -40\text{ to }125\text{ }^\circ\text{C}$ (unless otherwise specified. Typical values are referred to $25\text{ }^\circ\text{C}$).

Table 7. Electrical characteristics for ST1S12G12

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
OUT	Output feedback pin	$T_J = -40\text{ to }125\text{ }^\circ\text{C}$	1.164	1.2	1.236	V
I_O	V_O pin bias current			15	20	μA
V_{IN}	Minimum input voltage	$I_O = 10\text{ mA to }0.7\text{ A}$	2.5			V
I_Q	Quiescent current	$V_{IN} = V_{EN}$, $V_{FB} = 1.5\text{ V}$		500	650	μA
		$V_{EN} = 0$, $T = -40\text{ }^\circ\text{C to }85\text{ }^\circ\text{C}$			1	μA
I_O	Output current	$V_{IN} = 2.5\text{ V to }5.5\text{ V}^{(1)}$	0.7			A
V_{EN}	Enable threshold	Device ON, $V_{IN} = 2.5\text{ to }5.5\text{ V}$	1.5			V
		Device OFF			0.5	
I_{EN}	Enable pin current				1	μA
$\%V_O/\Delta V_{IN}$	Reference line regulation	$V_{IN} = 2.5\text{ V to }5.5\text{ V}^{(1)}$		0.05	0.1	$\%V_O/\Delta V_{IN}$
$\%V_O/\Delta I_O$	Reference load regulation	$I_O = 10\text{ mA to }700\text{ mA}^{(1)}$		0.0025	0.005	$\%V_O/\text{mA}$
PWMf _S	PWM switching frequency		1.16	1.7	2.08	MHz
$R_{DS(on)-N}$	NMOS switch on resistance	$I_{SW} = 100\text{ mA}$		0.25	0.4	Ω
$R_{DS(on)-P}$	PMOS switch on resistance	$I_{SW} = 100\text{ mA}$		0.25	0.45	Ω
I_{SWL}	Switching current limitation	⁽¹⁾		1.6		A
η	Efficiency ⁽¹⁾	$I_O = 10\text{ mA to }100\text{ mA}$		80		%
		$I_O = 100\text{ mA to }0.7\text{ A}$		85		
T_{SHDN}	Thermal shutdown		130	150		$^\circ\text{C}$
T_{HYS}	Thermal shutdown hysteresis			15		$^\circ\text{C}$
$\%V_O/\Delta I_O$	Load transient response	$I_O = 100\text{ mA to }700\text{ mA}$, $T_A = 25\text{ }^\circ\text{C}$ $t_R = t_F \geq 200\text{ ns}$, $C_O = 22\text{ }\mu\text{F}^{(1)}$	-5		+5	$\%V_O$
$\%V_O/\Delta I_O$	Short circuit removal response	$I_O = 10\text{ mA to }I_O = \text{short}$, $T_A = 25\text{ }^\circ\text{C}^{(1)}$	-10		+10	$\%V_O$

1. Guaranteed by design, but not tested in production.

$V_{IN} = V_{EN} = 3.6\text{ V}$, $C_{IN} = 4.7\text{ }\mu\text{F}$, $C_O = 10\text{ }\mu\text{F}$, $L = 2.2\text{ }\mu\text{H}$, $T_J = -40\text{ to }125\text{ }^\circ\text{C}$ (unless otherwise specified. Typical values are referred to $25\text{ }^\circ\text{C}$).

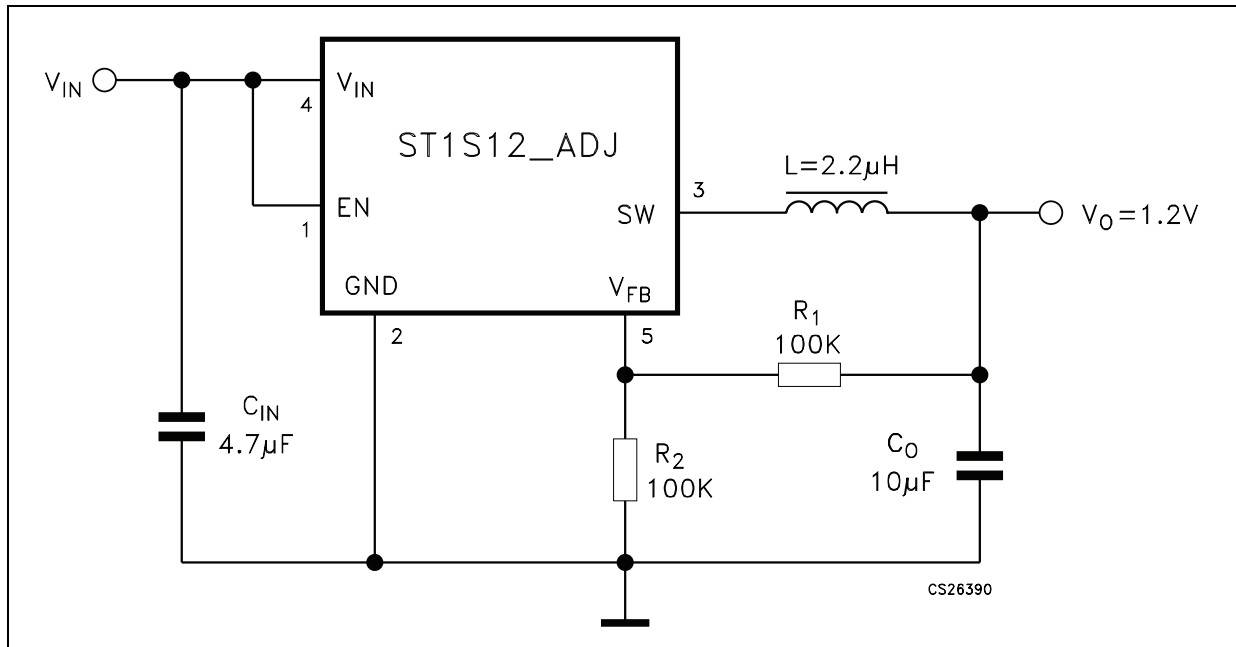
Table 8. Electrical characteristics for ST1S12G18

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
OUT	Output feedback pin	$T_J = -40\text{ to }125^\circ\text{C}$	1.746	1.8	1.854	V
I_O	V_O pin bias current			15	20	μA
V_{IN}	Minimum input voltage	$I_O = 10\text{mA to }0.7\text{A}$	2.5			V
I_Q	Quiescent current	$V_{IN} = V_{EN}$, $V_{FB} = 2\text{V}$		500	650	μA
		$V_{EN} = 0$, $T_J = -40^\circ\text{C to }85^\circ\text{C}$			1	μA
I_O	Output current	$V_{IN} = 2.5\text{V to }5.5\text{V}^{(1)}$	0.7			A
V_{EN}	Enable threshold	Device ON, $V_I = 2.5\text{V to }5.5\text{V}$	1.5			V
		Device OFF			0.5	
I_{EN}	Enable pin current				1	μA
$\%V_O/\Delta V_{IN}$	Reference line regulation	$V_{IN} = 2.5\text{V to }5.5\text{V}^{(1)}$		0.05	0.1	$\%V_O/\Delta V_{IN}$
$\%V_O/\Delta I_O$	Reference load regulation	$I_O = 10\text{mA to }700\text{mA}^{(1)}$		0.0025	0.005	$\%V_O/\text{mA}$
PWMf _S	PWM switching frequency		1.16	1.7	2.08	MHz
$R_{DS(on)-N}$	NMOS switch on resistance	$I_{SW} = 100\text{mA}$		0.25	0.4	Ω
$R_{DS(on)-P}$	PMOS switch on resistance	$I_{SW} = 100\text{mA}$		0.25	0.45	Ω
I_{SWL}	Switching current limitation	⁽¹⁾		1.6		A
η	Efficiency ⁽¹⁾	$I_O = 10\text{mA to }100\text{mA}$		80		%
		$I_O = 100\text{mA to }0.7\text{A}$		90		
T_{SHDN}	Thermal shutdown		130	150		$^\circ\text{C}$
T_{HYS}	Thermal shutdown hysteresis			15		$^\circ\text{C}$
$\%V_O/\Delta I_O$	Load transient response	$I_O = 100\text{mA to }700\text{mA}$, $T_A = 25^\circ\text{C}$ $t_R = t_F \geq 200\text{ns}$, $C_O = 22\text{ }\mu\text{F}^{(1)}$	-5		+5	$\%V_O$
$\%V_O/\Delta I_O$	Short circuit removal response	$I_O = 10\text{mA to }I_O = \text{short}$, $T_A = 25^\circ\text{C}^{(1)}$	-10		+10	$\%V_O$

1. Guaranteed by design, but not tested in production.

5 Typical application

Figure 3. Application circuit



6 Application notes

The ST1S12 is an adjustable current mode PWM step-down DC-DC converter with internal 0.7 A power switch, packaged in TSOT23-5L. This device is a complete 0.7 A switching regulator, with its internal compensation eliminating the need for additional components.

Because the ST1S12 an adjustable regulator, the output voltage is determined by an external resistor divider. The desired value is derived by the following equation:

Equation 1

$$V_O = V_{FB} [1 + R_1 / R_2]$$

For the device to function only a few component are required: an inductor, two capacitors and the resistor divider. The inductor selected must be capable of non saturation at peak current level. Moreover, its value can be selected taking into account that a large inductor value increases efficiency at low output current and reduces output voltage ripple, while a smaller inductor can be used when it is important to reduce package size and the total cost of the application. Finally, the ST1S12 has been designed to work properly with X5R or X7R SMD ceramic capacitors both at the input and at the output. These types of capacitors, due to their very low series resistance (ESR), minimize the output voltage ripple. Other low ESR capacitors can be used according to the need of the application without compromising the correct functioning of the device.

7 Typical performance characteristics

Unless otherwise specified, refer to the typical application circuit under the following conditions: $C_{IN} = 4.7 \mu F$, $C_{OUT} = 10 \mu F$, $L = 2.2 \mu H$

Figure 4. Voltage feedback vs. temperature **Figure 5. Drop vs. temperature**

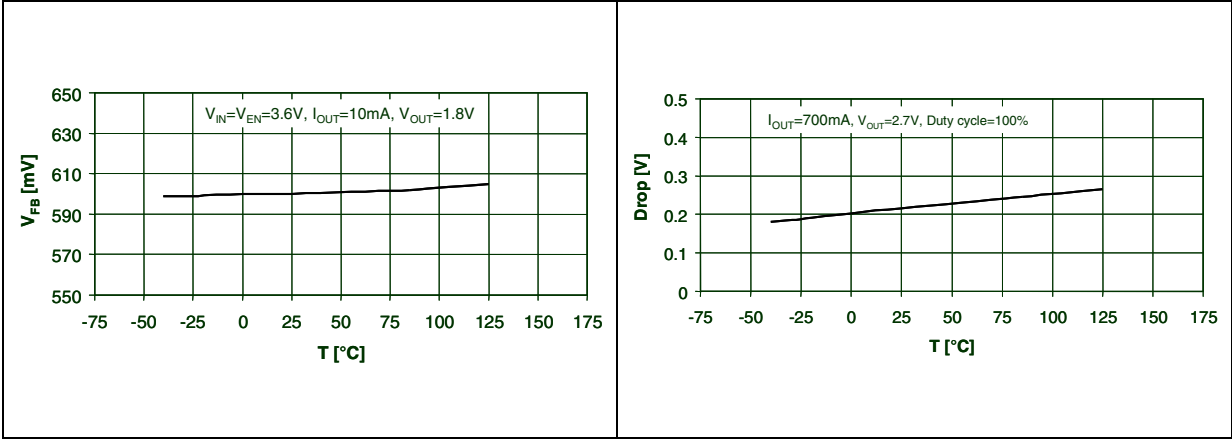


Figure 6. Oscillator frequency vs. temperature **Figure 7. Efficiency vs. output current**

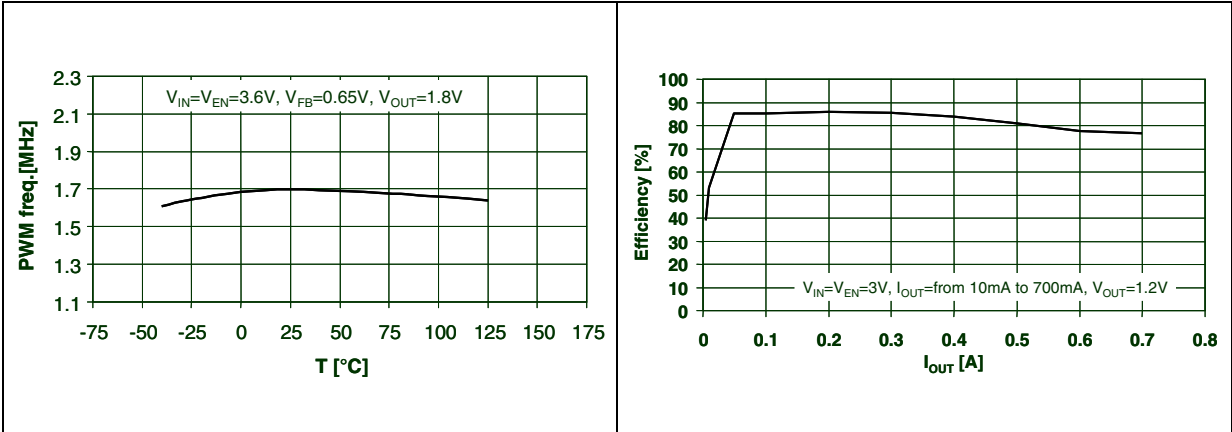


Figure 8. Efficiency vs. output current **Figure 9. Efficiency vs. temperature**

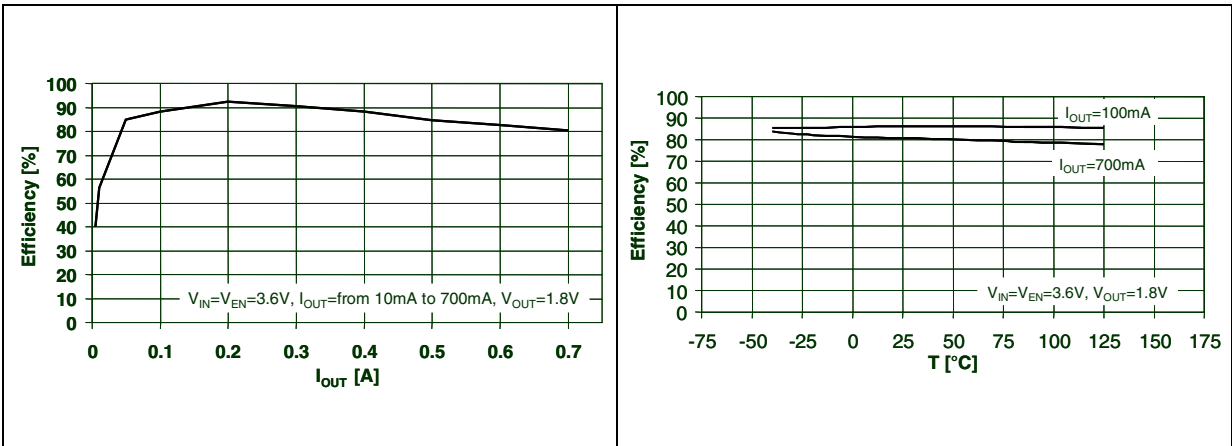


Figure 10. Efficiency vs. temperature

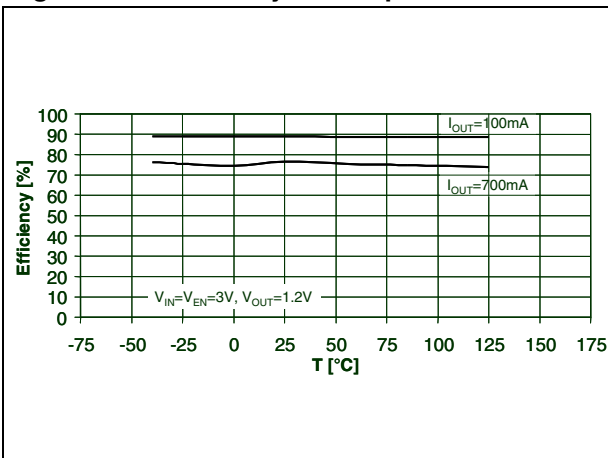


Figure 11. Supply current vs. temperature

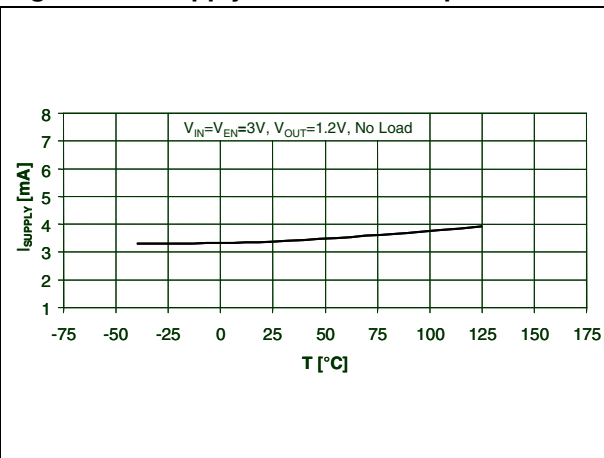


Figure 12. Quiescent current vs. temperature

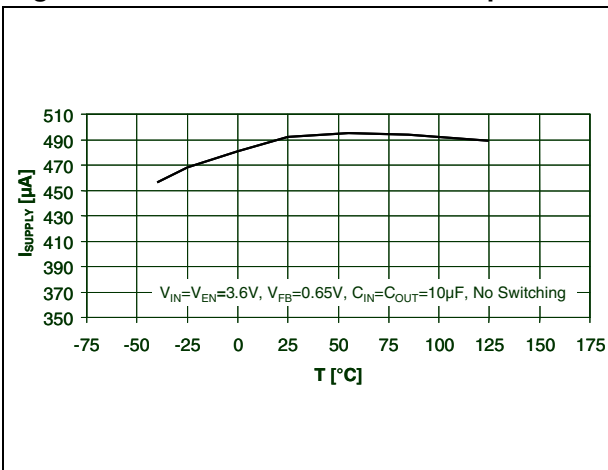


Figure 13. Enable voltage vs. temperature

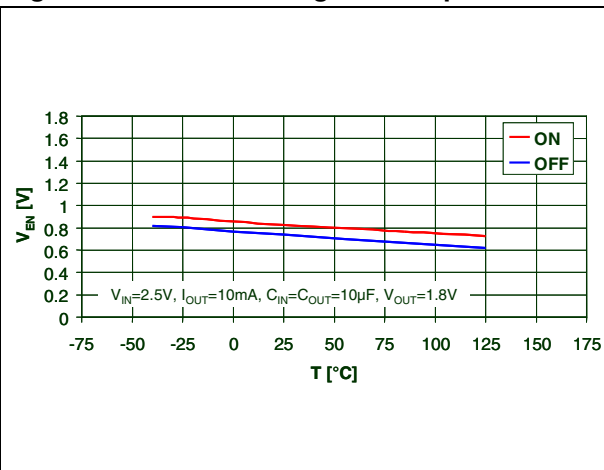


Figure 14. Enable voltage vs. temperature

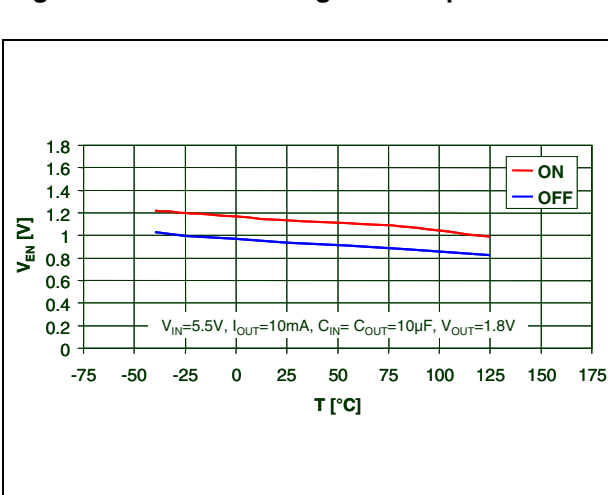


Figure 15. Reference line regulation vs. temperature

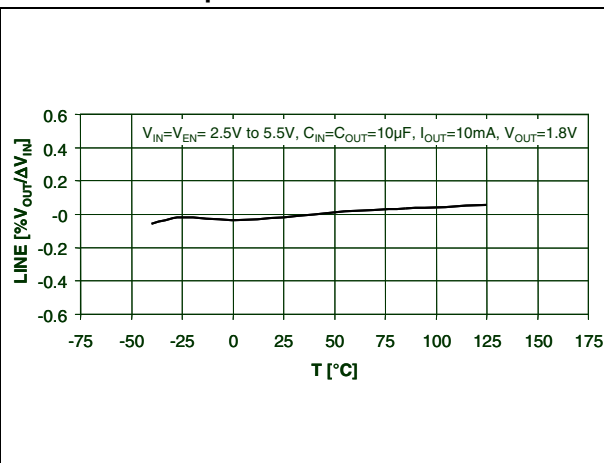


Figure 16. Reference load regulation vs. temperature

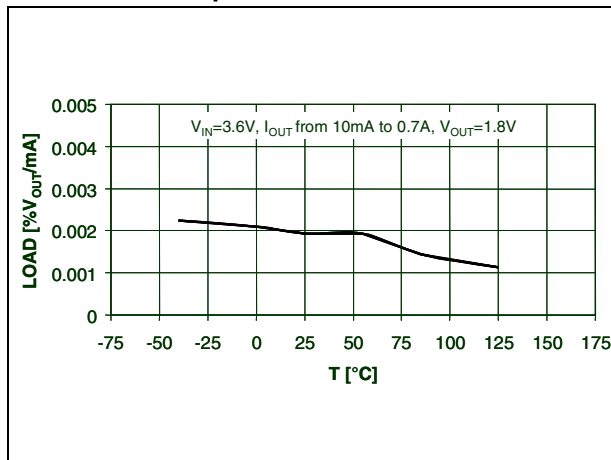


Figure 17. NMOS switch on resistance vs. temperature

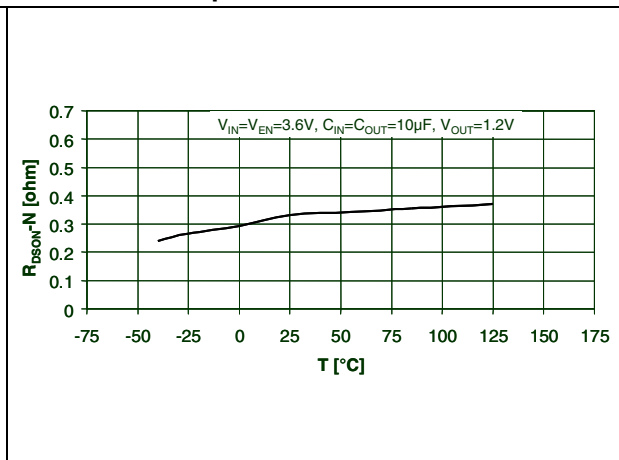


Figure 18. PMOS switch on resistance vs. temperature

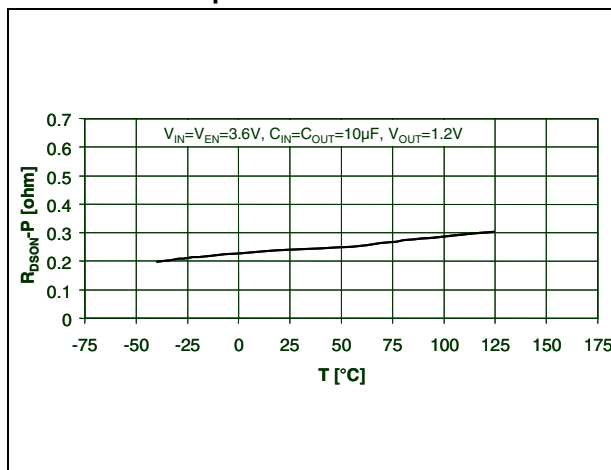


Figure 19. Switching current limitation vs. temperature

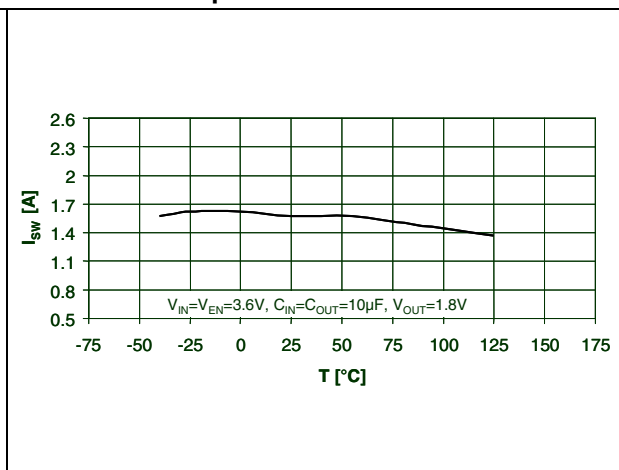


Figure 20. Switching current limitation vs. input voltage

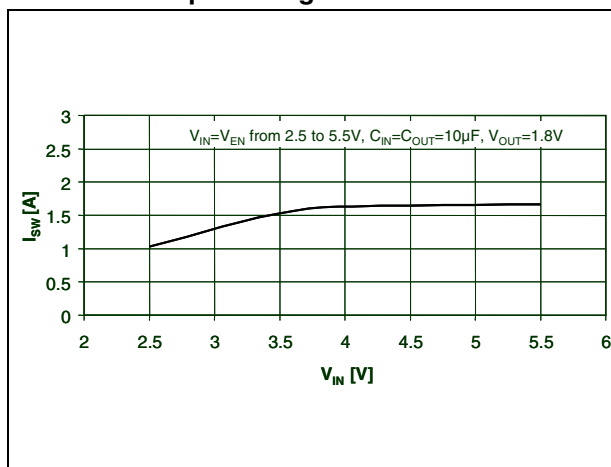


Figure 21. Output voltage vs. input voltage

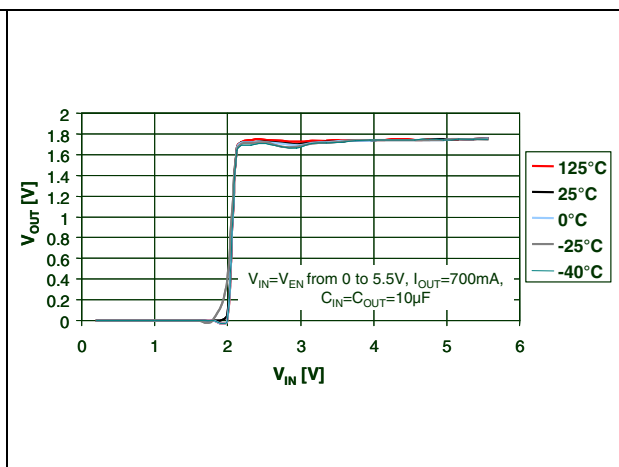


Figure 22. Line transient

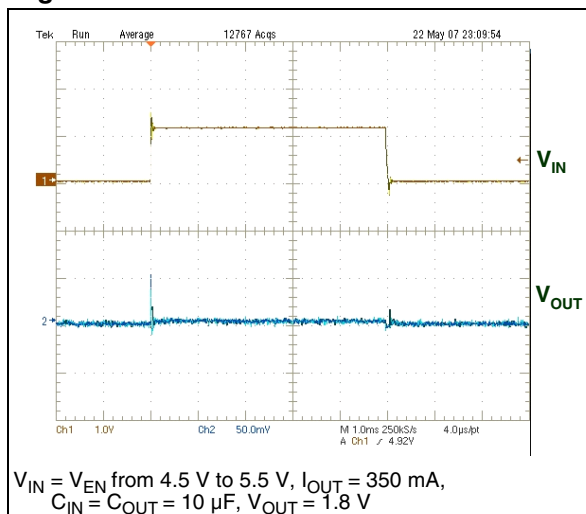


Figure 23. Load transient

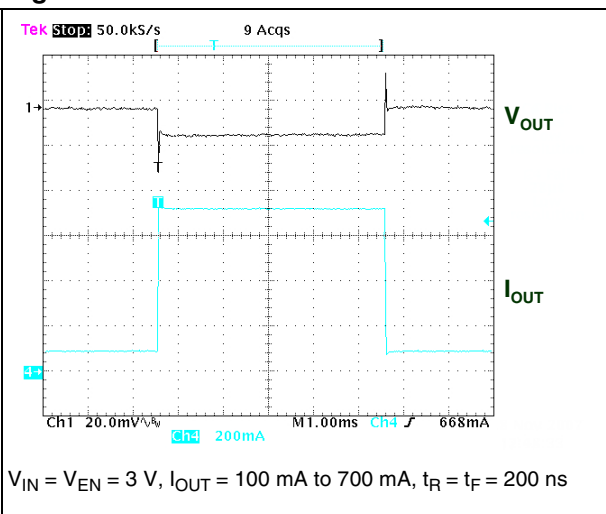


Figure 24. Start-up transient

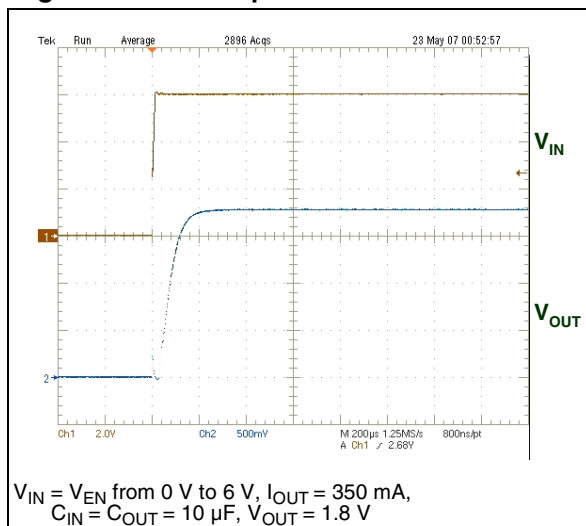
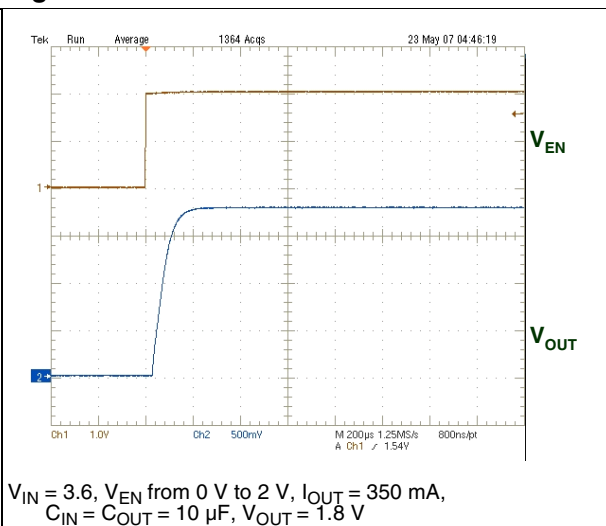


Figure 25. Enable transient

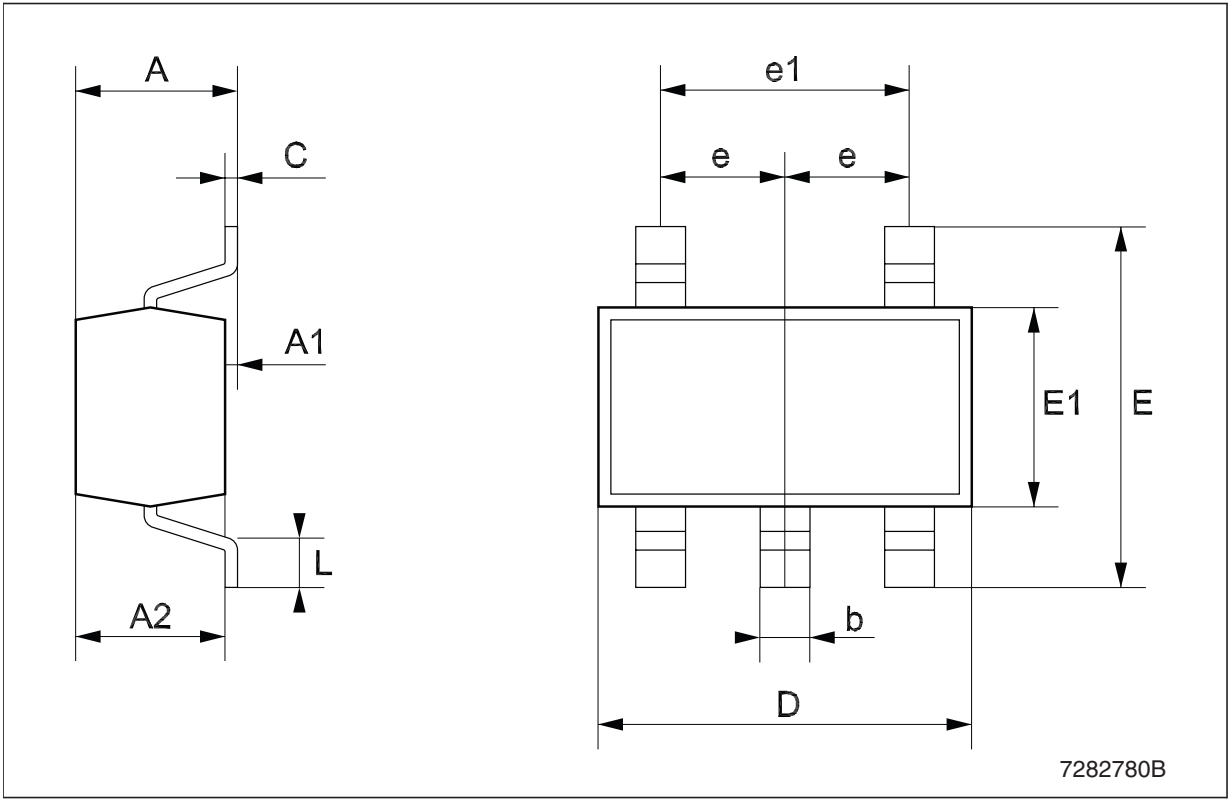


8 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

TSOT23-5L mechanical data

Dim.	mm.			mils.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.1			43.3
A1	0		0.1			3.9
A2	0.7		1.0	27.6		39.4
b	0.3		0.5	11.8		19.7
C	0.08		0.2	3.1		7.9
D		2.9			114.2	
E		2.8			110.2	
E1		1.6			63.0	
e		0.95			37.4	
e1		1.9			74.8	
L	0.3		0.6	11.8		23.6



Tape & reel TSOT23-5L mechanical data

Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			180			7.086
C	12.8	13.0	13.2	0.504	0.512	0.519
D	20.2			0.795		
N	60			2.362		
T			14.4			0.567
Ao	3.13	3.23	3.33	0.123	0.127	0.131
Bo	3.07	3.17	3.27	0.120	0.124	0.128
Ko	1.27	1.37	1.47	0.050	0.054	0.058
Po	3.9	4.0	4.1	0.153	0.157	0.161
P	3.9	4.0	4.1	0.153	0.157	0.161

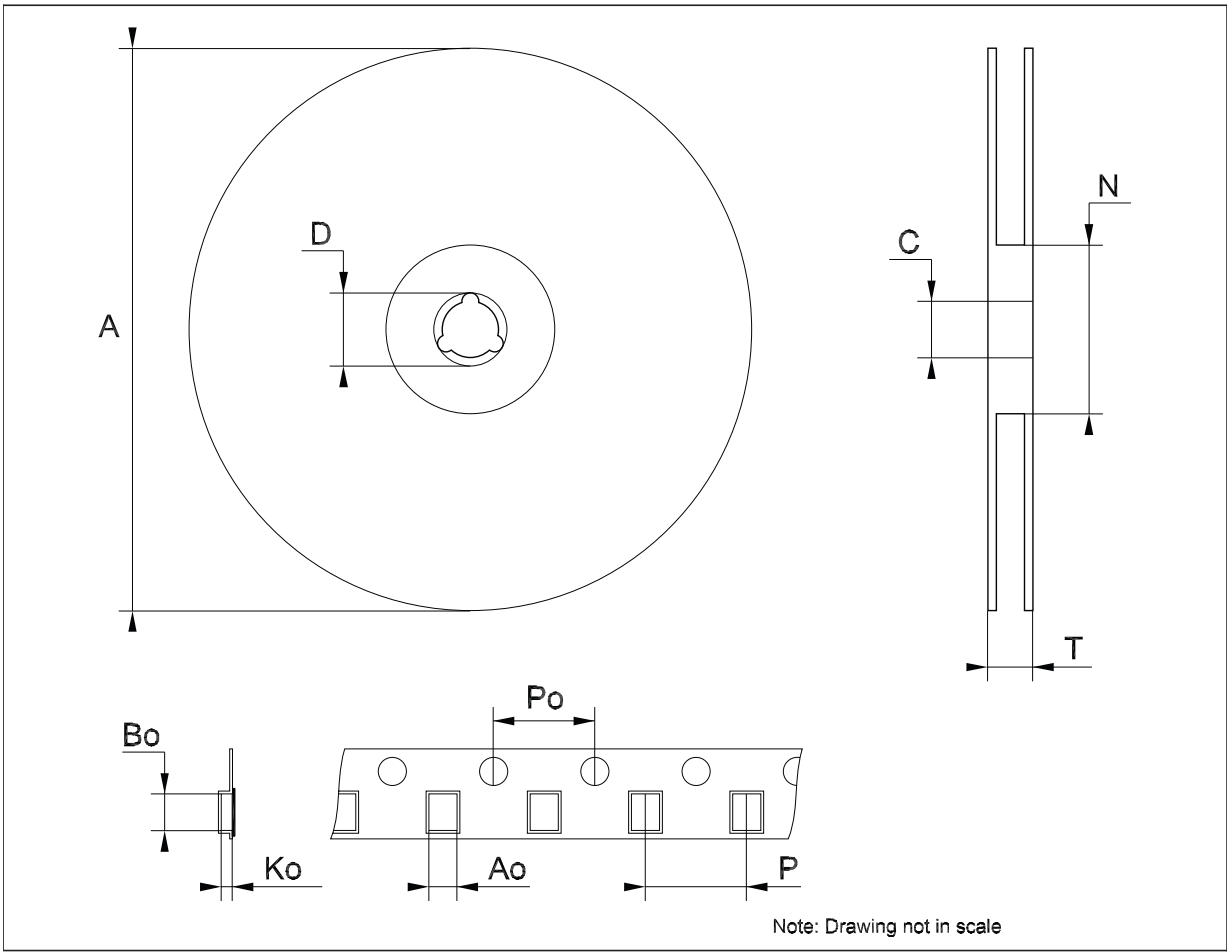


Figure 26. TSOT23-5L footprint recommended data

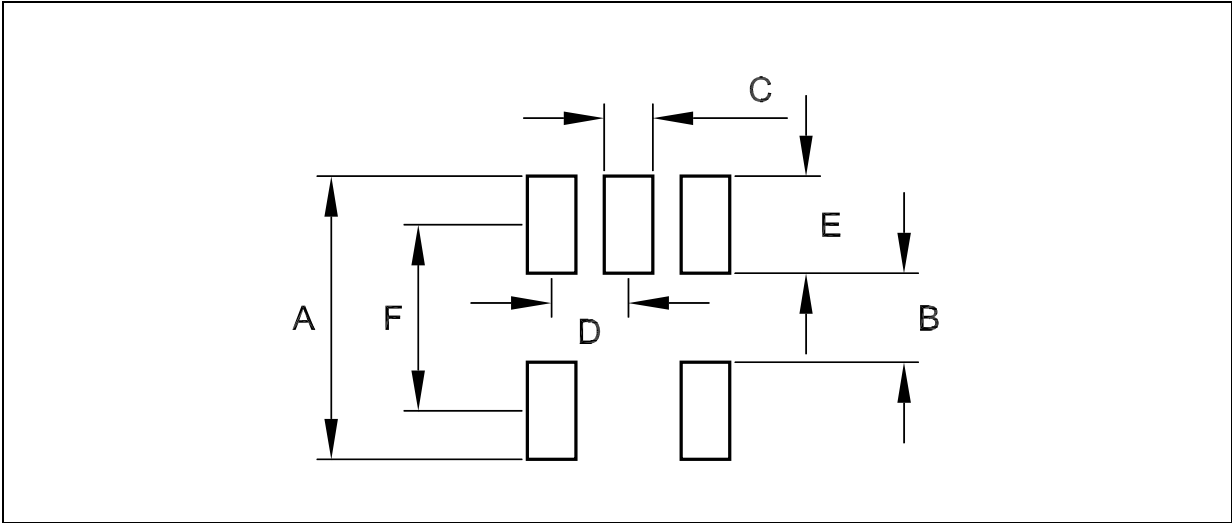


Table 9. Footprint data

Values		
	mm.	inch.
A	3.50	0.138
B	1.10	0.043
C	0.60	0.024
D	0.95	0.037
E	1.20	0.047
F	2.30	0.090

9 Revision history

Table 10. Document revision history

Date	Revision	Changes
10-Jan-2008	1	Initial release.
01-Feb-2008	2	Modified: Figure 3 on page 9 .
23-Feb-2010	3	Modified: V_{IN} value Table 3 on page 5 .
23-Jun-2011	4	Modified: FB unit Table 6 on page 6 .
17-Feb-2012	5	Modified: quiescent current max value 600 ==> 650 Table 6 on page 6 , Table 7 on page 7 and Table 8 on page 8 .

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